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Peregrine Semiconductor EK42552-02

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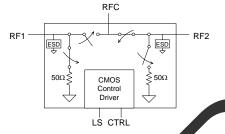


# **Product Description**

The PE42552 RF Switch is designed for use in Test/ATE, cellular and other wireless applications. This broadband general purpose switch maintains excellent RF performance and linearity from DC through 7500 MHz. The PE42552 integrates on-board CMOS control logic driven by a single-pin, low voltage CMOS control input. It also has a logic select pin which enables changing the logic definition of the control pin. Additional features include a novel user defined logic table, enabled by the on-board CMOS circuitry. The PE42552 also exhibits outstanding isolation of 44 dB at 7500 MHz, fast settling time, and is offered in a tiny 3x3 mm QFN package.

The PE42552 is manufactured on Peregrine's UltraCMOS™ process, a patented variation of silicon-on-insulator (SOI) technology on a sapphire substrate, offering the performance of GaAs with the economy and integration of conventional MOS.

Figure 1. Functional Diagram



# **Product Specification**

# PE42552

SPDT UltraCMOS™ RF Switch DC - 7500 MHz

#### **Features**

- HaRP™-Technology-Enhanced
  - Eliminates te and Phase Lag
  - No insertion loss or phase drift
  - Fast settling time
- High linearity: 65 dBm IIP3
- Low insertion loss. 0.65 dB at 3.0 GHz, 0.85 dB at 6.0 GHz, 1.0 at 7.5 GHz
- High isolation of 47 dB at 3.0 GHz,
   44 dB at 7.5 GHz
- 1 dB compression point: +34.5 dBm typ.
- Logic Select pin to invert logic control
- High ESD: 1000 V HBM
- Absorptive switch design
- Standard 3x3 mm QFN package

Figure 2. Package Type

6 lead 3x3 mm QFN



Table 1. Target Electrical Specifications Temp 25°C, V<sub>DD</sub> = 3.3V, V<sub>SS</sub> = 0V / -3.3V

Parameter	Conditions	Min	Typical	Max	Units
Operation Frequency MHz		9 kHz		7.5 GHz	
Insertion Loss	9 KHz 3000 MHz 6000 MHz		0.6 0.65 0.85	0.7 0.8 1.0	dB dB dB dB
Isolation – RF to RF2	7500 MHz 2000 MHz 6000 MHz 500 MHz	45 32 25	1.0 47 34 28	1.22	dB dB dB
Isolation – RFC to RFX	3000 MHz 6000 MHz 7500 MH	44 49 37	47 55 44		dB dB dB
Return Loss	3000 MHz 6000 MHz 7500 MHz		20 25 15		dB dB dB
Settling Time	50% CTRL to 0.05 dB final value -40 to +85 °C) Rising Edge 50% CTRL to 0.05 dB toal value -46 to +85 °C) Falling Edge		9 15	11 45	μs μs
Switching Time	50% CTRL to 90% or 10% of tinal value (-40 to +85 °C)		5	7	μs
Input 1 dB Compression	30 MHz 7500 MHz	32	34.5 34		dBm dBm
Input IP3	7500 MHz		65		dBm
Input IP2	7500 MHz		100		dBm

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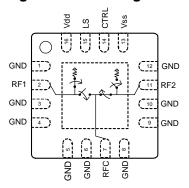
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## Figure 3. Pin Configuration (Top View)



**Table 2. Pin Descriptions** 

• • • • • • • • • • • • • • • • • • • •			
Pin No.	Pin Name	Description	
2	RF1	RF Port 1	
1, 3, 4, 5, 6, 8, 9, 10, 12	GND	Ground	
7	RFC	RF Common	
11	RF2	RF Port 2	
13	V <sub>SS</sub>	Negative supply voltage or GND connection (Note 1)	
14	CTRL	CMOS level:	
15	LS	Logic Select - Used to determine the definition for the CTRL pin (see Table 5)	
16	$V_{DD}$	Nominal 3.3 V supply connection	

Note: 1. Use VSS (pin 13, VSS = -VDD) to bypass and disable internal negative voltage generator. Connect VSS (pin 13) to GND (VSS = 0V) to enable internal negative voltage generator.

**Table 3. Operating Ranges** 

Parameter	Min	Тур	Max	Units
V <sub>DD</sub> Positive Power Supply Voltage	3.0	3.3	3,6	>
V <sub>SS</sub> Negative Power Supply Voltage (external power supply used)	3.6	-3.3	-3.0	V
V <sub>SS</sub> Negative Power Supply Voltage (internal power supply used)	-0.1	0.0	0.0	٧
I <sub>DD</sub> Power Supply Current (V <sub>SS</sub> = 0V, Temp = +85 °C)		15	120	μA
I <sub>SS</sub> Negative Supply (V <sub>SS</sub> = -V <sub>DB</sub> , Temp = 25 °C)		-10	-40	μA
Control Voltage High	0.7xV <sub>D</sub> D			V
Control Voltage Low			$0.3xV_{DD}$	<b>V</b>
T <sub>OP</sub> Operating temperature range	-40	25	85	.c
RF Power $In^{1}(P_{IN})$ : 8 kHz $\leq$ 1 MHz 1 MN $\leq$ 7 S GHz			fig. 4,5	dBm dBm

Note: 1. Please consult low reguency graphs on page 3 for recommender operating power level.

#### **Moisture Sensitivity Level**

The Moisture Sensitivity Level ratios for the PE42552 in the 16-lead 3x3mm QFN package is MSL1.

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#### **Table 4. Absolute Maximum Ratings**

Symbol	Parameter/Conditions	Min	Max	Units
$V_{DD}$	Power supply voltage	-0.3	4.0	V
VI	Voltage on any input except for CTRL and LS inputs	-0.3	V <sub>DD</sub> + 0.3	٧
V <sub>CTRL</sub>	Voltage on CTRL input		4.0	V
$V_{LS}$	Voltage on LS input		4.0	V
T <sub>ST</sub>	Storage temperature range	-65	150	°C
P <sub>IN</sub>	Input Power: 9 kHz ≤1 MHz 1 MHz ≤7.5 GHz		fig. 4,5 30	dBm dBm
V <sub>ESD</sub>	ESD voltage (HBM) ESD voltage (Machine Model)		1 <b>00</b> 0 100	V

Note: 1. Human Body Model (HBM, MIL\_STD 883 Method 3015.7)

Exceeding absolute maximum ratings may cause permanent damage. Operation should be restricted to the limits in the Operating Ranges table. Operation between operating range maximum and absolute maximum for extended periods may reduce reliability.

# **Electrostatic Discharge (ESD) Precautions**

When handling this UltraCMOSTM device, observe the same precautions that you would use with other ESD-sensitive devices. Although this device contains circuitry to protect it from damage due to ESD, precautions should be taken to avoid exceeding the rating specified.

### Latch-Up Avoidance

Unlike conventional CMOS devices, UltraCMOS™ devices are annune to latch-up.

# **Table 5 Control Logic Truth Table**

LS	CTRL	RFC-RF1	RFC-RF2
. 0	0	off	on
0	1	on	off
1	0	on	off
1	1	off	on

## Logic Select (LS)

Logic Select feature is used to determine the definition for the CTRL pin.

### Spurious Performance

The typical spurious performance of the PE42552 is -116 dBm when VSS=0V (pin 13 = GND). If further improvement is desired, the internal negative voltage generator can be disabled by setting VSS = -VDD.

# **Switching Frequency**

The PE42552 has a maximum 25 kHz switching rate when the internal negative voltage generator is used (pin 13=GND). The rate at which the PE42552 can be switched is only limited to the switching time (Table 1) if an external negative supply is provided at (pin13=VSS).

#### PE42552

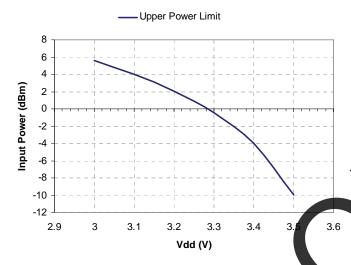
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### Low Frequency Power Handling: $Z_L = 50\Omega$

Figure 4 provides guidelines of how to adjust the Vdd and input Power to the 42552 device. The upper limit curve represents the maximum Input Power vs Vdd recommended for this part.

Figure 4. Maximum Operating Power Limit vs. Vdd and Input Power @ 9 KHz

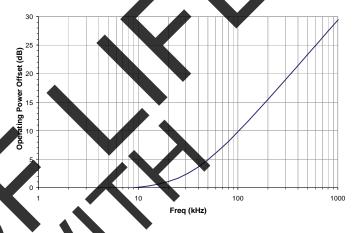


To allow for sustained operation under any load VSWR condition max power should be kept 6dB lower than max power in 50 Ohm.

Figure 5 shows how the power limit in Figure 4 will increase with frequency. As the frequency increases, the contours and Maximum Power Limit Curve will increase with the increase in power handling shown on the curve.

Figure 5. Operating Power Offset vs.

Frequency (Normalized to 9kHz)



### **Power Handling Examples**

Example 1: Maximum power handling at 100kHz, Z=50 bhms, VSWR-1:1, and Vdd=3V

- The power handling offset for 100kHz from Fig. 5 is
- The max power handling at Vdd = 3V is 5.5dB from
   Fig. 4
- Derate power under mismatch conditions
- Total maximum power handling for this example is 10dB + 5.5dB = 15.5dBm



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Figure 6. Nominal Insertion Loss: RF1, RF2

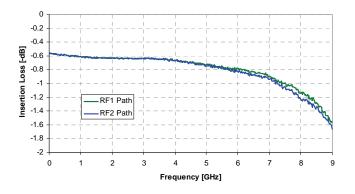


Figure 7. Insertion Loss: RFX @ 3.3 V

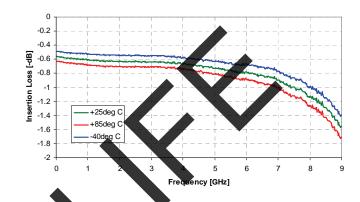


Figure 8. Insertion Loss: RFX @ 25 °C

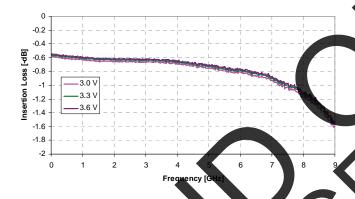


Figure 9. Isolation: Active Port to Isolated Port @ 3.3 V

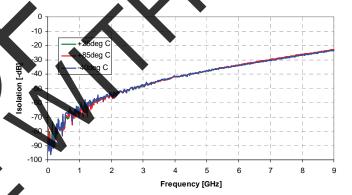


Figure 10. Isolation: Active Port to Isolated Port @ 25 °C

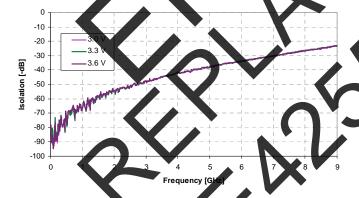
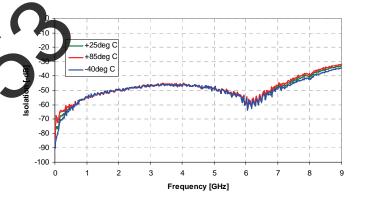


Figure 11. Isolation: RFC to Isolated Port @ 3.3 V



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Figure 12. Isolation: RFC to Isolated Port @ 25 °C

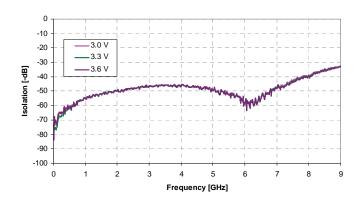


Figure 13. IIP3: Third Order Distortion from 10kHz - 7.5GHz

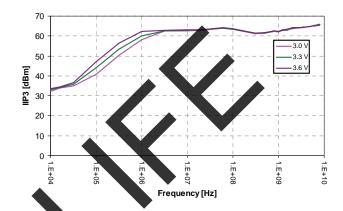


Figure 14. Return Loss at active port @ 25 °C

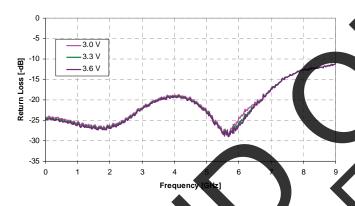
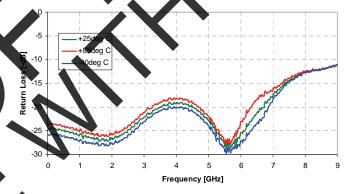


Figure 15. Return Loss at active port @ 3.3 V



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#### **Evaluation Kit**

The SPDT switch EK Board was designed to ease customer evaluation of Peregrine's PE42552. The RF common port is connected through a 50  $\Omega$ transmission line via the top SMA connector, J1. RF1, RF2, RF3 and RF4 are connected through 50  $\Omega$  transmission lines via SMA connectors J3, J5, J2 and J4, respectively. A through 50  $\Omega$ transmission is available via SMA connectors J6 and J7. This transmission line can be used to estimate the loss of the PCB over the environmental conditions being evaluated.

The evaluation kit board is constructed of four metal layers. The dual clad top RF layer is Rogers RO4003 material with an 8 mil RF core and er = 3.55. The other two dielectric layers are FR4 for DC control and overall board strength with an cumulative board thickness of 60 mils. The RF transmission lines were designed using a Grounded co-planar waveguide with a linewidth of 15 mils and gap of 10 mils.

Figure 16. Evaluation Board Layouts Peregrine Specification 101/0334

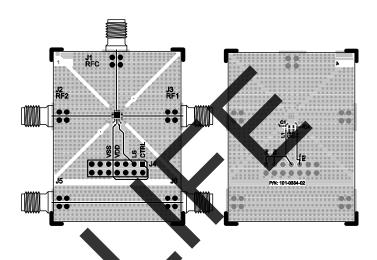
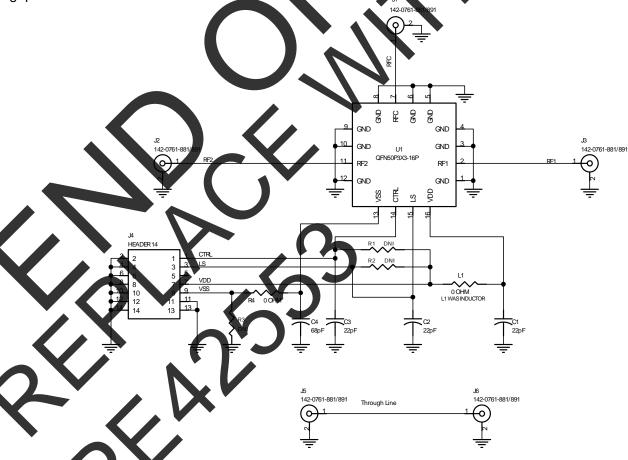


Figure 17. Evaluation **Board Schematic** regrine Spec 2/0404 cation



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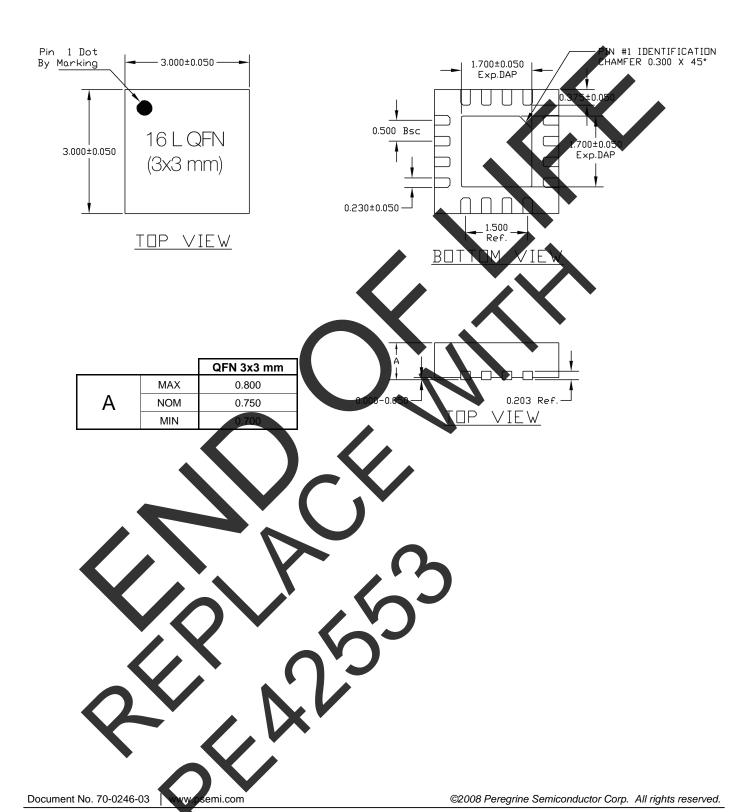
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Figure 18. Package Drawing (mm)

16-lead 3x3 mm QFN



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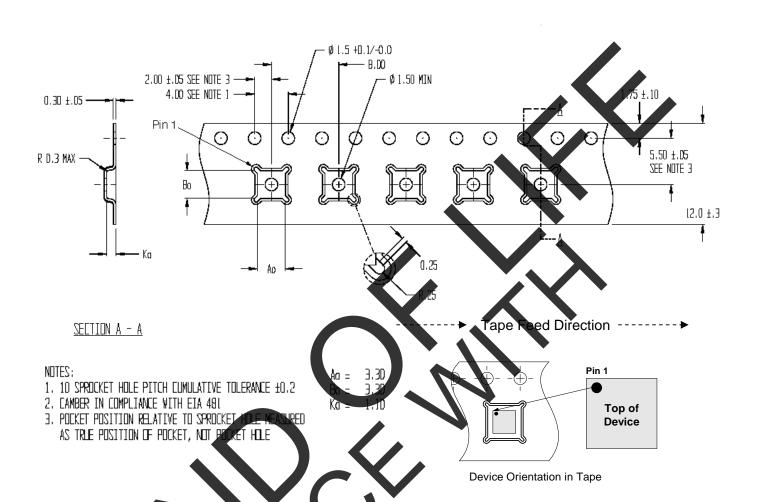
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### Figure 19. Tape and Reel Specifications

16-lead 3x3 mm QFN



#### ng Informatio Table 6. O

Order Code	Part Marking	Description	Package	Shipping Method
PE42552MLIB	42552	PE42552G-16QFN 3x3mm 75A	Green 16-lead 3x3mm QFN	Bulk or tape cut from reel
PE42552MLIB-Z	42552	PE42552G-160FN 3x3mm-3000C	Green 16-lead 3x3mm QFN	3000 units / T&R
EK42552-02	PE42552-EK	PE42552-16QFN 3x3mm-EK	Evaluation Kit	1 / Box

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